





MIRTEC MV-6E OMNI 3D AOI Machine with SPC Software 950KG

Basic Information

Place of Origin: Korea
Brand Name: MIRTEC
Model Number: MV-6E (OMNI)

• Minimum Order Quantity: 1 PCS

Price: USD+negotiable+pcsPackaging Details: 1180mm*1570mm*1660mm

Delivery Time: 1-7 daysPayment Terms: T/T

Supply Ability: 1+pcs+per days



Product Specification

Model: MV-6E (OMNI)

PCB Size: 50mm×50mm~480mm×460mm

Height Accuracy: ±3um Maximum Component 5mm

Height:

• 2D Detection Items: Missing Piece, Offset, Skew, Stellation, Side

Stand, Turn Over Piece, Polar Reverse, Wrong Piece, Damage, Tin, Virtual Welding,

Cavity, OCR

• 3D Detection Items: Missing Parts, Height, Position, More Tin,

Less Tin, Missing Welding, Double Chip, Size, IC Foot Virtual Welding, Foreign Matter, Parts Cocking, BGA Cocking,

Climbing Tin Detection, Etc

• FOV Field Of View: 58.56mm×58.56mm

3D Detection Speed: 0.80 Seconds /FOV/4.260mm²/ Second
 2D Detection Speed: 0.30 Seconds /FOV/ 10,716 Mm²/ Second



More Images



MIRTEC 3D AOI MV-6E OMNI 950KG SPC Complete Statistical Software For Inspection

Key Specifications

Attribute	Value
Model	MV-6E (OMNI)
PCB size	50mm×50mm~480mm×460mm
Height accuracy	±3um
Maximum component height	5mm
FOV field of view	58.56mm×58.56mm
3D detection speed	0.80 seconds /FOV/4.260mm²/ second
2D detection speed	0.30 seconds /FOV/ 10,716 mm²/ second
Weight	950KG

Detection Capabilities

2D Detection: missing piece, offset, skew, stellation, side stand, turn over piece, polar reverse, wrong piece, damage, tin, virtual welding, cavity, OCR

3D Detection: missing parts, height, position, more tin, less tin, missing welding, double chip, size, IC foot virtual welding, foreign matter, parts cocking, BGA cocking, climbing tin detection

Technical Features

Accurate telecentric composite lens

8-segment color lighting system

Complete statistical software (SPC)

PCB clearance: 45mm
PCB thickness: 0.5~5mm

Minimum measurement size: 03015 Servo motor positioning system

Repeatability: ±10um

DVLP 8-group moorfringe technology

Performance Highlights

100% testing capability for all materials on PCB

Detection of character/screen print on mobile phone glass chips

Effective inspection of PCBA coated with three anti-coating paint

15-megapixel high-resolution camera



The MIRTEC MV-6E(OMNI) is a complete 3D online optical inspection device featuring advanced detection capabilities, high-speed performance, and comprehensive statistical software for quality control in manufacturing processes.

Physical Specifications

Dimensions: 1080mm (W) × 1470mm (D) × 1560mm (H)

Power Supply: 200-240VAC 50Hz/60Hz

Air Source: 5KGf/cm² (0.5Mpa)









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